

SBL530 - SBL560

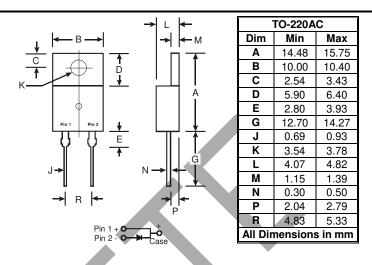
**5.0A SCHOTTKY BARRIER RECTIFIER** 

# Features

- Schottky Barrier Chip
- Guard Ring Die Construction for Transient Protection
- Low Power Loss, High Efficiency
- **High Surge Capability**
- High Current Capability and Low Forward Voltage Drop
- For Use in Low Voltage, High Frequency Inverters, Free Wheeling, and Polarity Protection Application
- Lead Free Finish, RoHS Compliant (Note 3)

# **Mechanical Data**

- Case: TO-220AC
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020C
- Terminals: Finish Tin. Solderable per MIL-STD-202, Method 208 (e3)
- Polarity: See Diagram
- Marking: Type Number
- Weight: 2.3 grams (approximate)



#### Maximum Ratings and Electrical Characteristics $@T_A = 25^{\circ}C$ unless otherwise specified

Single phase, half wave, 60Hz, resistive or inductive load.

For capacitive load, derate current by 20%.								
Characteristic	Symbol	SBL 530	SBL 535	SBL 540	SBL 545	SBL 550	SBL 560	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	30	35	40	45	50	60	v
RMS Reverse Voltage	V <sub>R(RMS)</sub>	21	24.5	28	31.5	35	42	V
Average Rectified Output Current (Note 1) @ T <sub>C</sub> = 95°C	Ι <sub>Ο</sub>	5.0					А	
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I <sub>FSM</sub>	175			А			
Forward Voltage Drop $@ I_F = 5.0A, T_C = 25^{\circ}C$	V <sub>FM</sub>	0.55 0.70			70	V		
Peak Reverse Current $@ T_C = 25^{\circ}C$ at Rated DC Blocking Voltage $@ T_C = 100^{\circ}C$	I <sub>RM</sub>	0.5 33			mA			
Typical Junction Capacitance (Note 2)	Cj	500			pF			
Typical Thermal Resistance Junction to Case (Note 1)	$R_{\theta JC}$	3			°C/W			
Operating and Storage Temperature Range	Tj, TSTG	-65 to +150				°C		

 Thermal resistance junction to case mounted on heatsink.
Measured at 1.0MHz and applied reverse voltage of 4.0V DC. Notes:

3. RoHS revision 13.2.2003. Glass and high temperature solder exemptions applied, see EU Directive Annex Notes 5 and 7.



PART OBSOLETE – NO ALTERNATE PART

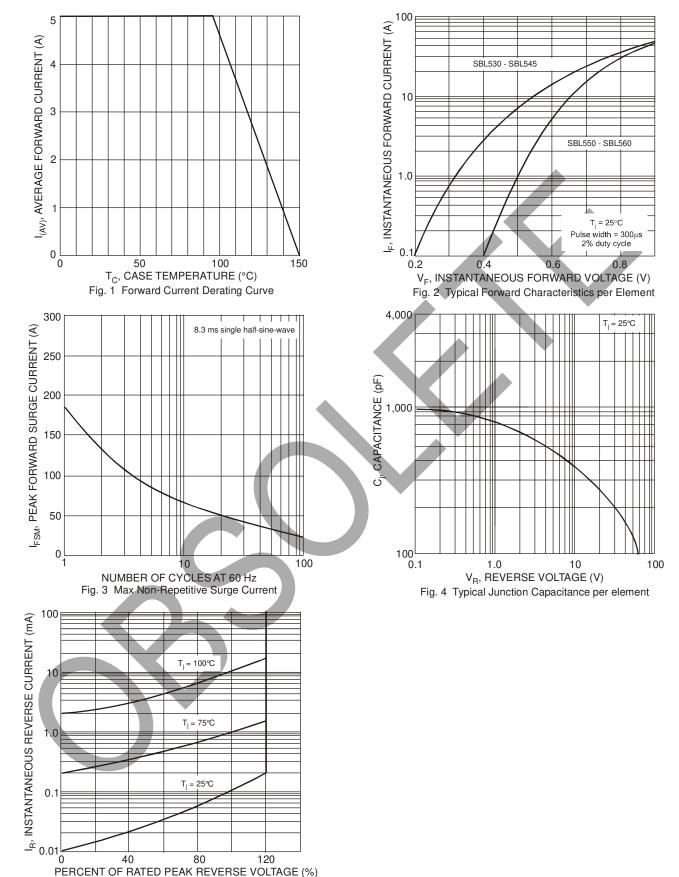


Fig. 5 Typical Reverse Characteristics



## Ordering Information (Note 4)

Device	Packaging	Shipping
SBL5xx*	TO-220AC	50/Tube

\* xx = Device type, e.g. SBL545

Notes: 4. For packaging details, visit our website at http://www.diodes.com/datasheets/ap02008.pdf.

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